

Internally Matched LNA Module

Features

- · S₂₁ = 16.4 dB @ 1500 MHz = 15.4 dB @ 1600 MHz
- · NF of 0.65 dB over Frequency
- · Unconditionally Stable
- · Single 5V Supply
- · High OIP3 @ Low Current

Description

The plerow™ ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.







1-stage Single Type

Specifications (in Production)

Typ. @ T = 25°C, V_s = 5 V, Freq. = 1500 MHz, $Z_{o.sys}$ = 50 ohm

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Parameter	Unit	Specifications			
Farameter	Offic	Min	Тур	Max	
Frequency Range	Range MHz			1600	
Gain	dB	14.9	15.9		
Gain Flatness	dB		± 0.5	± 0.7	
Noise Figure	dB		0.65	0.70	
Output IP3 (1)	dBm	25	26		
S11 / S22 (2)	dB			-18 / -10	
Output P1dB	dBm	11	12		
Switching Time	μsec		-		
Supply Current	mA		30	35	
Supply Voltage	V		5		
Impedance	Ω	50			
Max. RF Input Power	dBm	C.W 29 ~ 31 (before fail)			
Package Type & Size	mm	Surface Mount Type, 10Wx10Lx3.8H			

More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

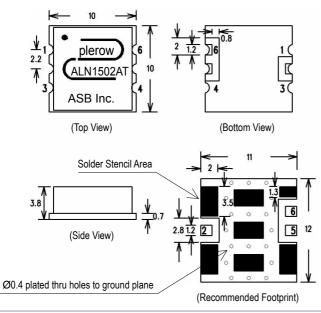
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ASB Inc., 4th Fl. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Operating temperature is -40°C to +85°C.

- 1) OIP3 is measured with two tones at an output power of 0 dBm / tone separated by 1 MHz.
 2) S11/S22 (max) is the worst value within the frequency band.
 3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_S.

Outline Drawing (Unit: mm)



Pin Number	Function		
2	RF In		
5	RF Out		
6	+Vcc		
Others	Ground		

Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

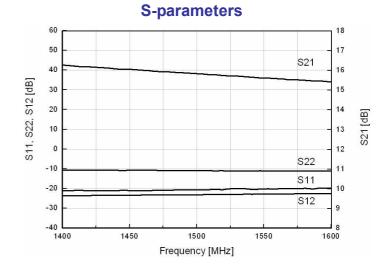
2. We recommend that the ground via holes be

placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

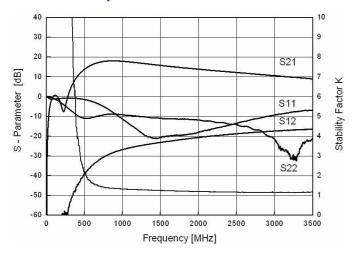


Internally Matched LNA Module

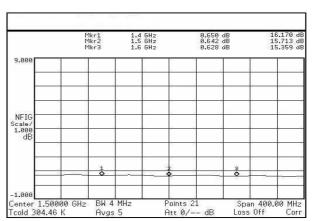




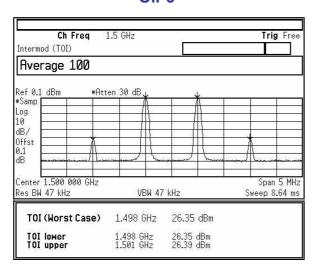
S-parameters & K Factor



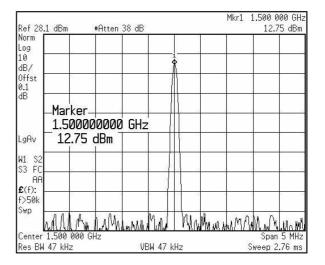
Noise Figure



OIP3



P1dB





RF Performance with Voltage Change

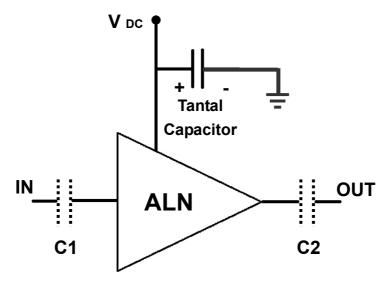
Item Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-17.16	-9.28	16.10	0.84	0.643	10.70	24.14	21
4.6	-17.66	-9.36	16.14	0.85	0.621	11.12	24.85	22
4.7	-18.10	-9.42	16.17	0.83	0.622	11.60	25.37	23
4.8	-18.59	-9.47	16.19	0.85	0.627	11.91	25.66	24
4.9	-19.08	-9.52	16.21	0.84	0.627	12.52	26.34	25
5.0	-19.53	-9.57	16.23	0.84	0.636	12.76	26.81	26
5.1	-19.97	-9.59	16.25	0.84	0.632	13.19	27.25	27
5.2	-20.35	-9.63	16.27	0.84	0.620	13.54	27.77	28
5.3	-20.81	-9.64	16.28	0.84	0.627	13.99	27.94	30
5.4	-21.21	-9.68	16.30	0.85	0.634	14.27	28.51	31
5.5	-21.61	-9.68	16.31	0.85	0.631	14.49	28.59	32

RF Performance with Operating Temperature

Item Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-19.68	-9.52	16.49	0.83	0.374	12.15	26.10	24
- 20°C	-19.68	-9.58	16.44	0.84	0.447	12.45	26.49	25
0°C	-19.70	-9.60	16.36	0.84	0.545	12.68	26.60	26
25°C	-19.75	-9.78	16.05	0.85	0.649	13.22	27.10	26
40°C	-19.54	-9.63	16.11	0.86	0.666	13.24	27.15	27
60°C	-19.29	-9.61	16.03	0.85	0.737	13.18	27.02	28
80°C	-19.05	-9.56	15.89	0.87	0.804	13.08	27.10	28
100°C	-18.76	-9.57	15.83	0.88	0.900	13.11	27.16	29

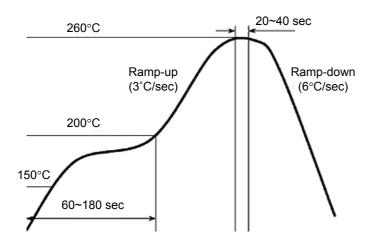


Application Circuit

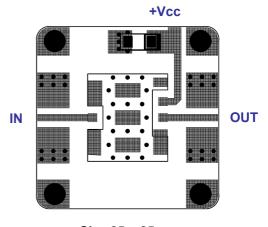


- 1) The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

Recommended Soldering Reflow Process



Evaluation Board Layout



Size 25 x 25mm (for ALN-AT, BT, T Series – 10x10mm)